



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

Device	V _{(BR)DSS}	R _{DS(ON)}	I _D T _A = +25°C
Q1	12V	17mΩ @ V _{GS} = 4.5V	9.5A
QI	121	25mΩ @ V _{GS} = 2.5V	7.8A
Q2	-20V	$32m\Omega @ V_{GS} = -4.5V$	-6.9A
Q2		53mΩ @ V _{GS} = -2.5V	-5.4A

Description and Applications

This new generation Complementary Pair Enhancement Mode MOSFET has been designed to minimize $R_{DS(ON)}$ and yet maintain superior switching performance. This device is ideal for use in Notebook battery power management and Loadswitch.

- Notebook Battery Power Management
- DC-DC Converters
- Loadswitch

Features and Benefits

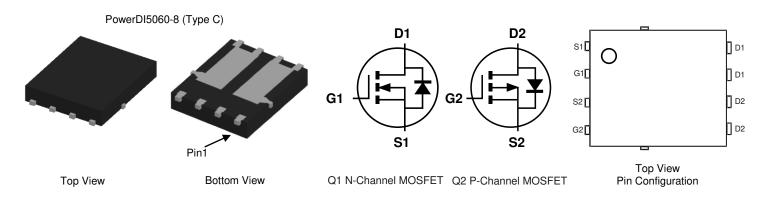
- Thermally Efficient Package-Cooler Running Applications
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q101, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

https://www.diodes.com/products/automotive/automotiveproducts/.

 This part is qualified to JEDEC standards (as references in AEC-Q101) for High Reliability. <u>https://www.diodes.com/guality/product-definitions/</u>

Mechanical Data

- Case: PowerDI[®]5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish 100% Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Terminal Connections: See Diagram Below
- Weight: 0.097 grams (Approximate)



Ordering Information (Note 4)

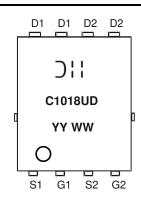
Part Number	Case	Packaging			
DMC1018UPD-13	PowerDI5060-8 (Type C)	2500 / Tape & Reel			
Notes: 1 No purposely added lead Fully FLI Directive 2002/05/FC (BoHS) 2011/65/FLI (BoHS 2) & 2015/863/FLI (BoHS 3) compliant					

No purposely added read. Fully ED Directive 2002/52/EC (Nons), 2017/52/EC (Nons 2) & 2013/63/ED (Nons 3) Compliant.
See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</p>

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.





);; = Manufacturer's Marking C1018UD = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 15 = 2015) WW = Week (01 - 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Q1 Value	Q2 Value	Units		
Drain-Source Voltage	V _{DSS}	12	-20	V		
Gate-Source Voltage	V _{GSS}	±8	±12	V		
Continuous Drain Current (Note 5) V 45V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	9.5 7.6	-6.9 -5.5	А
Continuous Drain Current (Note 5) $V_{GS} = 4.5V$	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	13.0 10.4	-9.4 -7.5	А
Maximum Body Diode Forward Current (Note 5)		ls	2.5	-2.5	А	
Pulsed Drain Current (10µs pulse, duty cycle = 1	I _{DM}	60	-40	А		
Avalanche Current (Note 6) L = 0.1mH	I _{AS}	20	-17	А		
Avalanche Energy (Note 6) L = 0.1mH			E _{AS}	25	14	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Units	
Total Power Dissinction (Note 5)	$T_A = +25^{\circ}C$	D-	2.3	W
Total Power Dissipation (Note 5)	$T_A = +70^{\circ}C$	PD	1.5	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	54	
Thermal Resistance, Junction to Amplent (Note 5)	t<10s	R _{θJA}	29	°C/W
Thermal Resistance, Junction to Case		R _{eJC}	6.5	
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. 6. I_{AS} and E_{AS} rating are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$.



Electrical Characteristics Q1 N-Channel (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)			1 71		1 -	
Drain-Source Breakdown Voltage	BV _{DSS}	12	_	_	V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current	I _{DSS}		_	1	μA	$V_{DS} = 12V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}		_	±100	nA	$V_{GS} = \pm 8V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						-
Gate Threshold Voltage	V _{GS(TH)}	0.6	0.8	1.5	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Static Drain-Source On-Besistance	Б	_	8	17	mΩ	V _{GS} = 4.5V, I _D = 11.8A
Static Drain-Source On-Resistance	R _{DS(ON)}	_	11	25	11122	$V_{GS} = 2.5V, I_D = 9.8A$
Diode Forward Voltage	V _{SD}	_	0.7	1.2	V	$V_{GS} = 0V, I_S = 2.9A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}	_	1525	—	pF	$V_{DS} = 6V, V_{GS} = 0V,$ f = 1.0MHz
Output Capacitance	C _{oss}	_	329	—		
Reverse Transfer Capacitance	Crss	_	303	—		
Gate Resistance	R _G	_	1.6	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	17.1	—		
Total Gate Charge (V _{GS} = 8V)	Qg	_	30.4	—	nC	
Gate-Source Charge	Qgs	_	2.6	—	nc	$V_{DS} = 6V, I_D = 11.8A$
Gate-Drain Charge	Q _{gd}	_	4.3	—		
Turn-On Delay Time	t _{D(ON)}	_	6.6	—		
Turn-On Rise Time	t _R	_	10.8	—		$V_{DD} = 6V, R_L = 6\Omega$
Turn-Off Delay Time	t _{D(OFF)}	_	41.5		ns	$V_{GS}=4.5V,\ R_G=6\Omega,\ I_D=1A$
Turn-Off Fall Time	tF		21.9	_	1	
Body Diode Reverse Recovery Time	t _{RR}	_	14.3	—	ns	I _F = 11.8A, di/dt = 100A/µs
Body Diode Reverse Recovery Charge	Q _{RR}		2.3	_	nC	I _F = 11.8A, di/dt = 100A/µs

7. Short duration pulse test used to minimize self-heating effect.8. Guaranteed by design. Not subject to product testing. Notes:



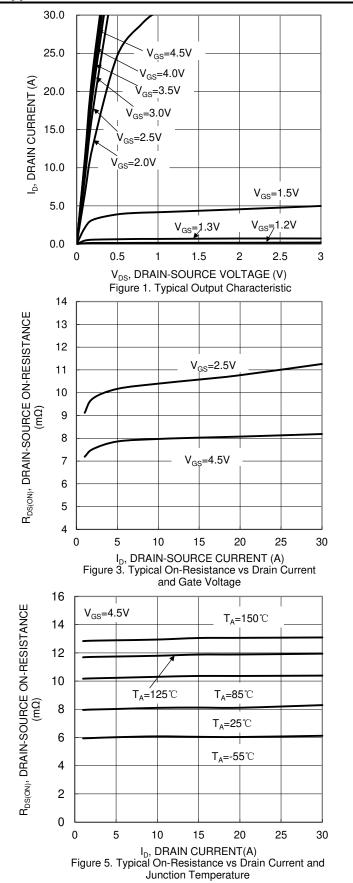
Electrical Characteristics Q2 P-Channel (@T_A = +25°C, unless otherwise specified.)

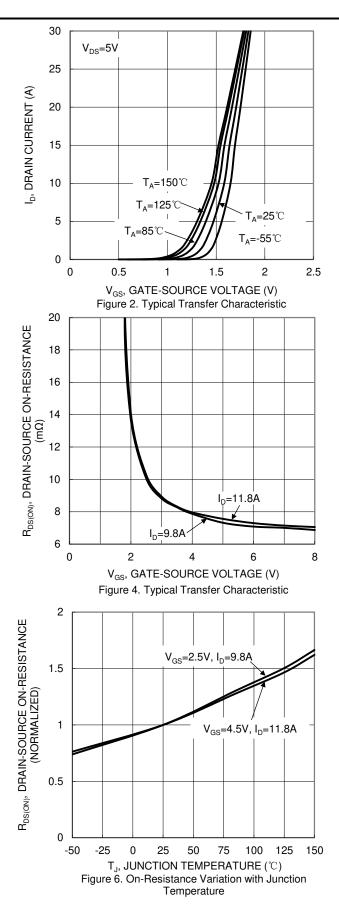
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	-20	—	—	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-1	μΑ	$V_{DS} = -16V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}		_	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)			•	•	•	·
Gate Threshold Voltage	V _{GS(TH)}	-0.6	-0.8	-1.5	V	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$
Static Drain-Source On-Resistance	Р	_	22	32	mΩ	$V_{GS} = -4.5V, I_D = -8.9A$
Static Drain-Source On-nesistance	R _{DS(ON)}	_	31	53	11122	$V_{GS} = -2.5V, I_D = -6.9A$
Diode Forward Voltage	V _{SD}		-0.7	-1.2	V	$V_{GS} = 0V, I_S = -2.9A$
DYNAMIC CHARACTERISTICS (Note 8)	•		•	•	•	·
Input Capacitance	C _{iss}	_	866	—	pF	$V_{DS} = -6V, V_{GS} = 0V,$ f = 1.0MHz
Output Capacitance	C _{oss}	_	167	—		
Reverse Transfer Capacitance	Crss	_	131	—		
Gate Resistance	R _G	_	4.9	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	8.6	—		
Total Gate Charge (V _{GS} = -8V)	Qg	_	19	—	nC	
Gate-Source Charge	Q _{gs}	_	1.5	—	10	$V_{DS} = -6V, I_D = -8.9A$
Gate-Drain Charge	Q _{gd}		2.5	_		
Turn-On Delay Time	t _{D(ON)}		5.8	_		
Turn-On Rise Time	t _R		7.7	_		$V_{DD} = -6V, R_L = 6\Omega$
Turn-Off Delay Time	t _{D(OFF)}		28.1	_	ns	$V_{GS} = -4.5V, R_G = 6\Omega, I_D = -1A$
Turn-Off Fall Time	tF	_	14.6	—	1	
Body Diode Reverse Recovery Time	t _{RR}	_	9.8	—	ns	I _F = -8.9A, di/dt = -100A/µs
Body Diode Reverse Recovery Charge	Q _{RR}	_	2.7	_	nC	I _F = -8.9A, di/dt = -100A/µs

7. Short duration pulse test used to minimize self-heating effect.8. Guaranteed by design. Not subject to product testing. Notes:

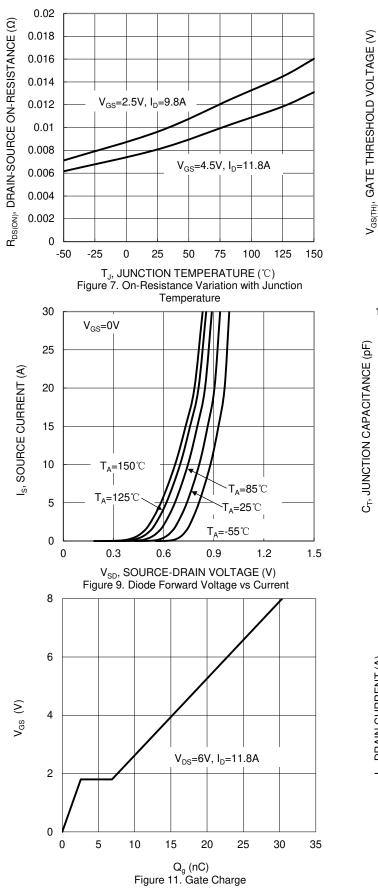


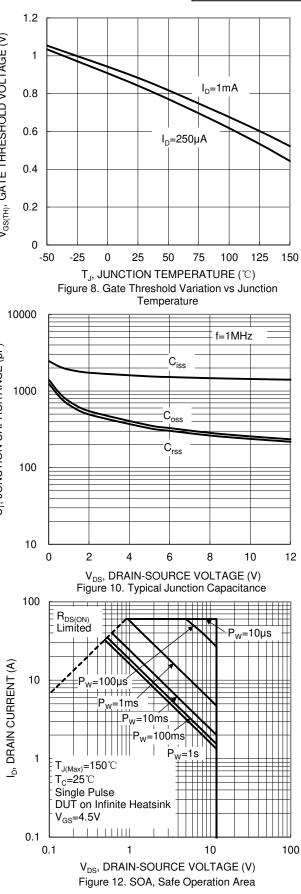
Typical Characteristics - N-CHANNEL







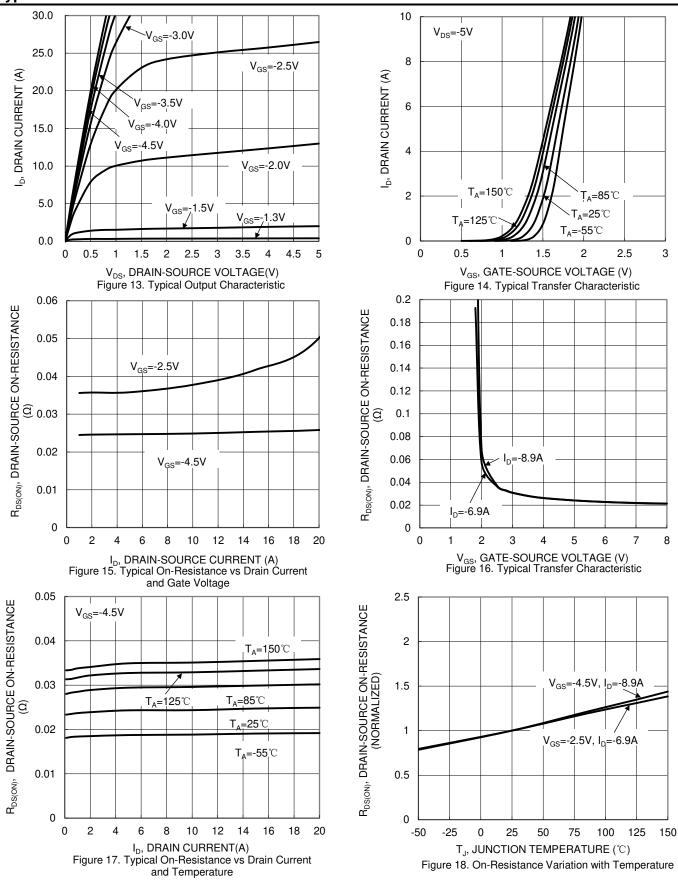




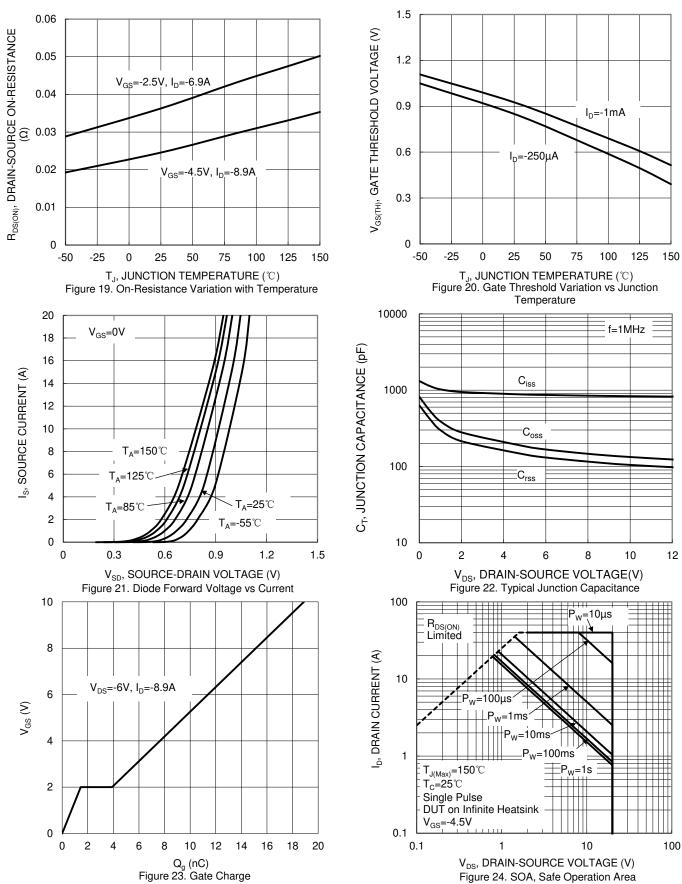
DMC1018UPD Document number: DS38533 Rev. 3 - 2 October 2019 © Diodes Incorporated



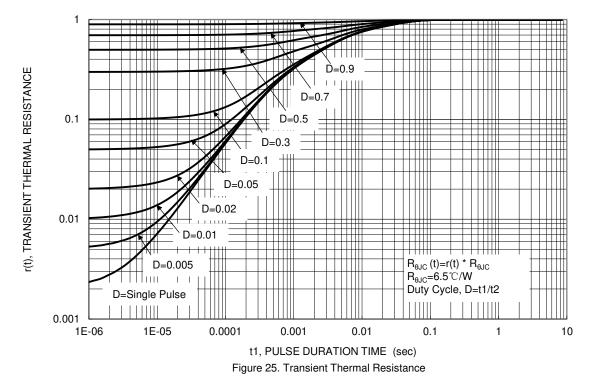
Typical Characteristics - P-CHANNEL









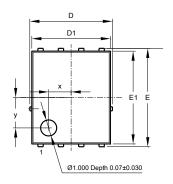


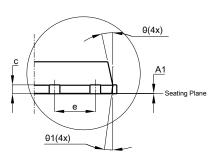


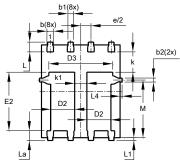
Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

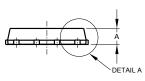
PowerDI5060-8 (Type C)









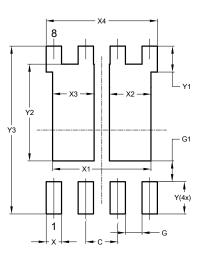


Pow	erDI506	0-8 (Typ	be C)				
Dim	Min	Тур					
Α	0.90	1.10	1.00				
A1	0	0.05	0.02				
b	0.33	0.51	0.41				
b1	0.300	0.366	0.333				
b2	0.20	0.35	0.25				
С	0.23	0.33	0.277				
D	5	.15 BS0	0				
D1	4.85	4.95	4.90				
D2	1.40	1.60	1.50				
D3	-	-	3.98				
Е	6.15 BSC						
E1	5.75	5.85	5.80				
E2	3.56	3.76	3.66				
е	1.27BSC						
k	-	-	1.27				
k1	0.56	-	-				
L	0.51	0.71	0.61				
La	0.51	0.71	0.61				
L1	0.05	0.20	0.175				
L4	-	-	0.125				
М	3.50	3.71	3.605				
х	-	-	1.400				
У	-	-	1.900				
θ	10°	12°	11°				
θ1	6°	8°	7°				
All	All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.





Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	3.910
X2	1.650
X3	1.650
X4	4.420
Y	1.270
Y1	1.020
Y2	3.810
Y3	6.610



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